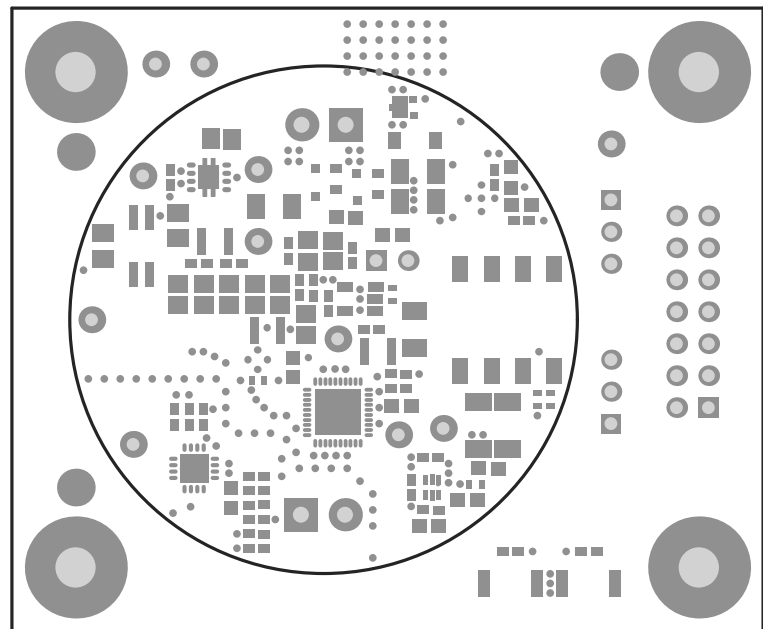
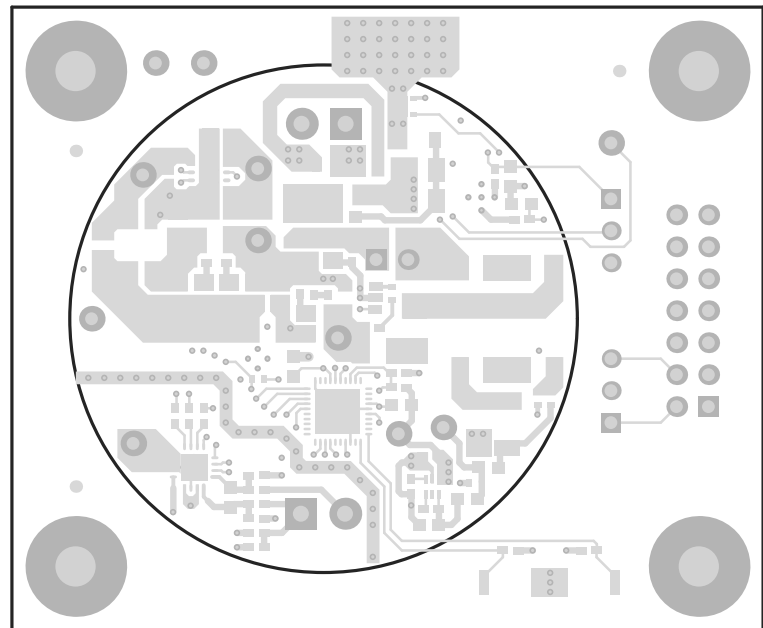


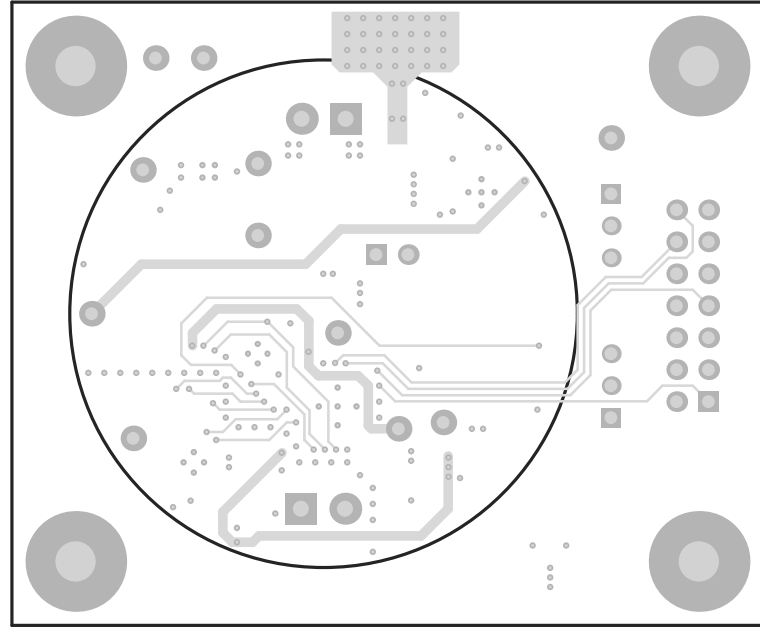
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00189	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 9/19/2014 10:29:23 AM	TEXAS INSTRUMENTS	



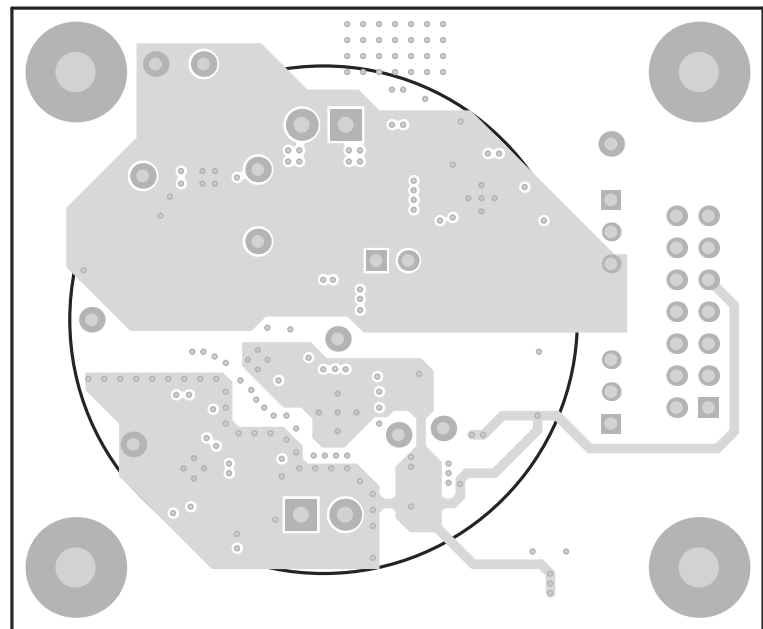
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00189	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 9/19/2014 10:29:23 AM	TEXAS INSTRUMENTS	



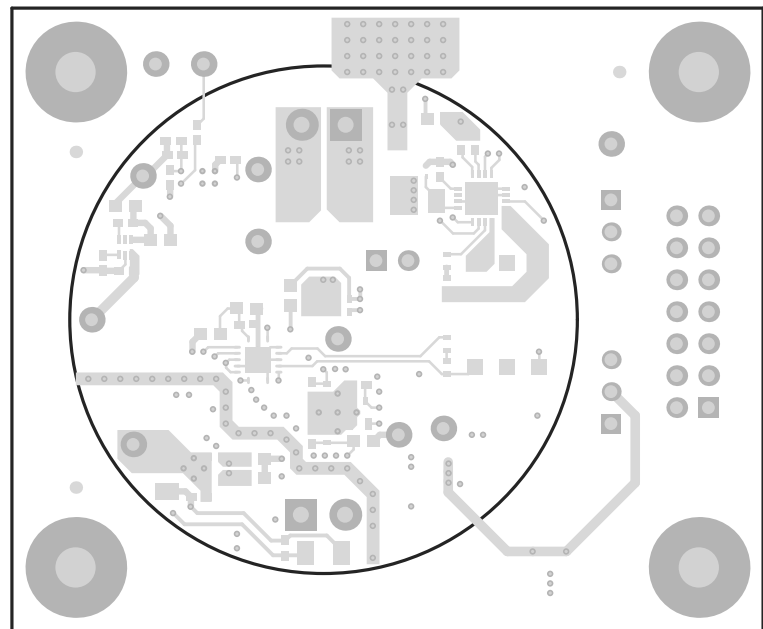
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00189	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 1 - Top Layer			
PLOT NAME = Top Layer	GENERATED : 9/19/2014 10:29:23 AM	TEXAS INSTRUMENTS	



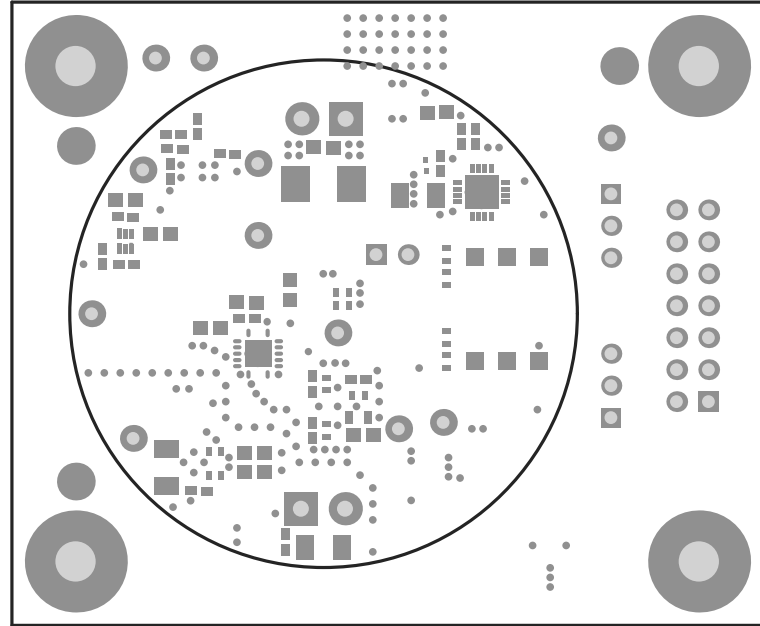
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00189	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 3 - Inner Layer			
PLOT NAME = MidLayer1	GENERATED : 9/19/2014 10:29:24 AM	TEXAS INSTRUMENTS	



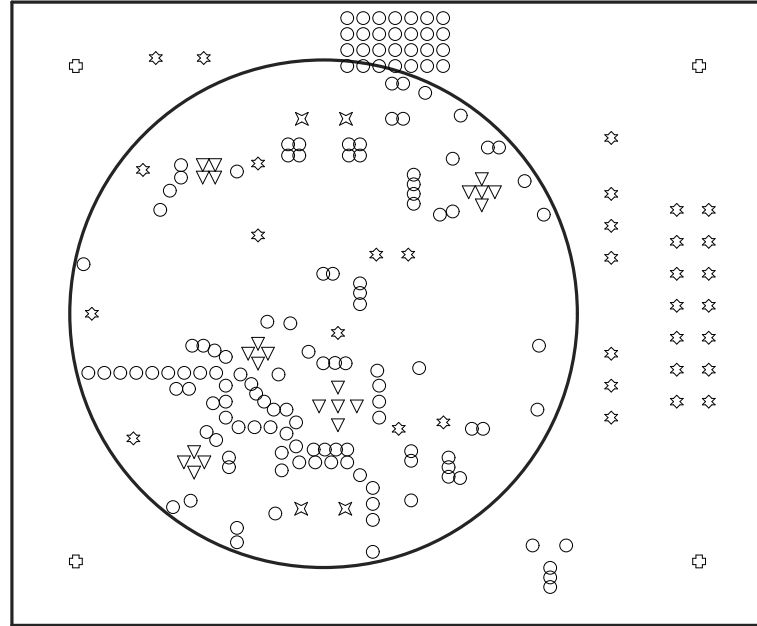
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00189	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 2 - GND			
PLOT NAME = MidLayer2	GENERATED : 9/19/2014 10:29:24 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00189	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Layer 4 - Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 9/19/2014 10:29:24 AM	TEXAS INSTRUMENTS	



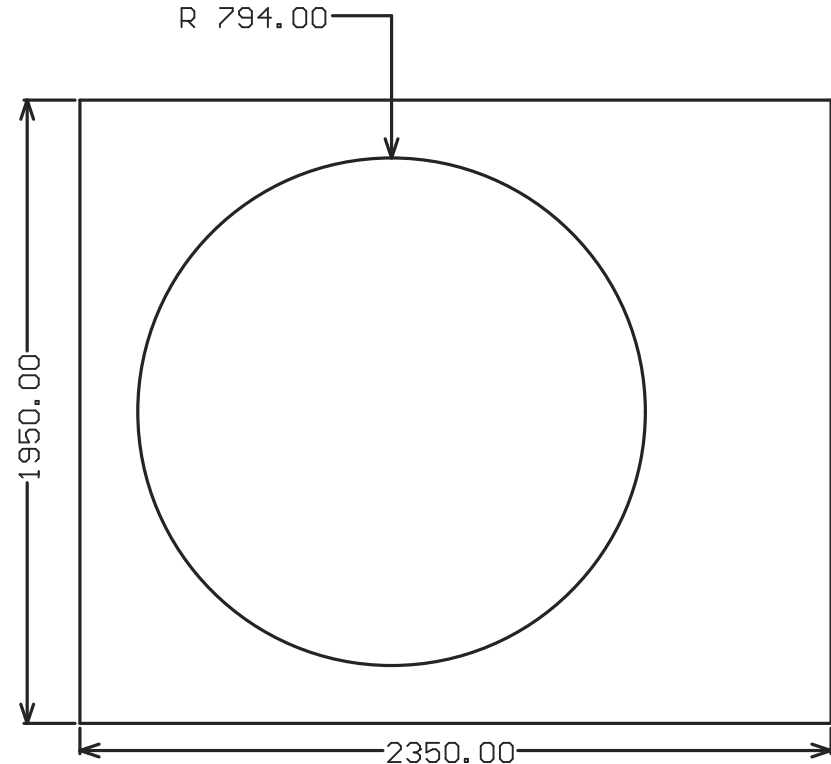
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00189	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 9/19/2014 10:29:25 AM	TEXAS INSTRUMENTS	



Symbol	Hit Count	Tool Size	Plated	Hole Type
▽	22	7.874mil (0.2mm)	PTH	Round
○	147	10mil (0.254mm)	PTH	Round
☆	33	40mil (1.016mm)	PTH	Round
✧	4	50mil (1.27mm)	PTH	Round
⊕	4	125.984mil (3.2mm)	PTH	Round
210 Total				

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00189	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 9/19/2014 10:29:25 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00189	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 9/19/2014 10:29:26 AM	TEXAS INSTRUMENTS	

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